

**Features**

- Package in 8mm tape on a 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Multi-color type.
- Pb-free.
- RoHS compliant version.



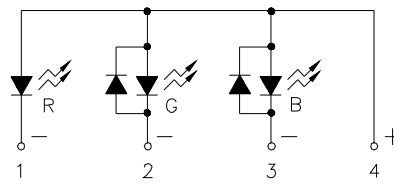
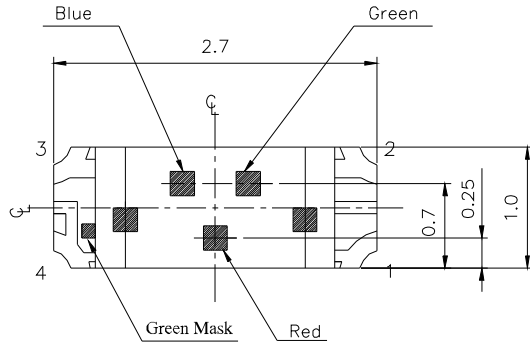
**Descriptions**

- The SMD Taping is much smaller than lead frame type components, thus enable smaller board size, higher packing density and reduced storage space and finally smaller equipment to be obtained.
- Light weigh makes them ideal for miniature applications.

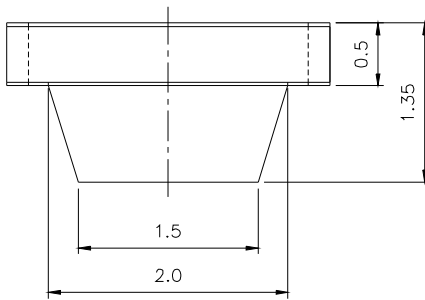
**Device Selection Guide**

Chip			Lens Color
Type	Material	Emitted Color	
R6	AlInGaN	Brilliant Red	Water Clear
GH	InGaN	Brilliant Green	
BH	InGaN	Blue	

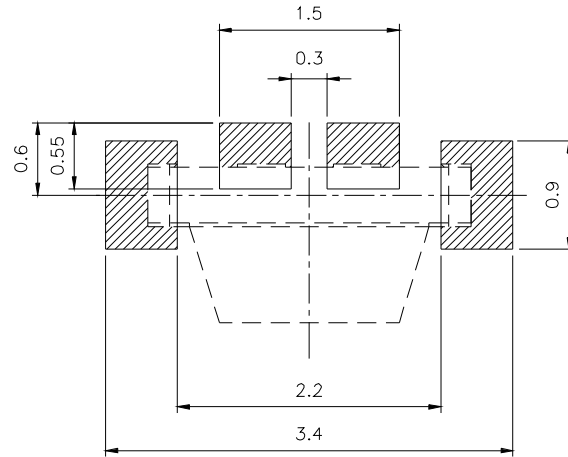
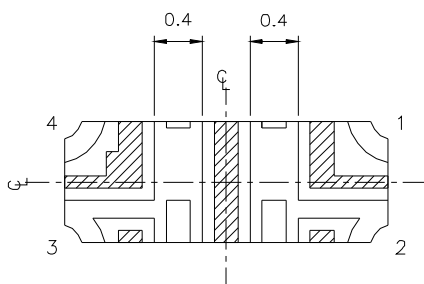
### Package Outline Dimensions



Polarity



For reflow soldering (propose)



**Note:** The tolerances unless mentioned is  $\pm 0.1\text{mm}$ , Unit = mm

**Absolute Maximum Ratings (Ta=25°C)**

Parameter	Symbol	Rating	Unit
Reverse Voltage	V <sub>R</sub>	5	V
Forward Current	I <sub>F</sub>	R6:25 GH:25 BH:25	mA
Operating Temperature	T <sub>opr</sub>	-40 ~ +85	°C
Storage Temperature	T <sub>stg</sub>	-40 ~ +90	°C
Power Dissipation	P <sub>d</sub>	R6:60 GH:110 BH:110	mW
Peak Forward Current (Duty 1/10 @1KHz)	I <sub>FP</sub>	R6:60 GH:100 BH:100	mA
Soldering Temperature	T <sub>sol</sub>	Reflow Soldering : 260 °C for 10 sec Hand Soldering : 350 °C for 3 sec.	

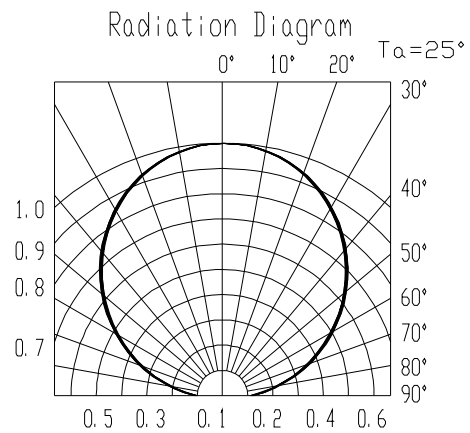
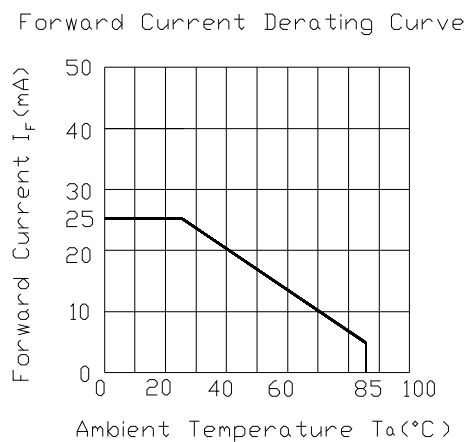
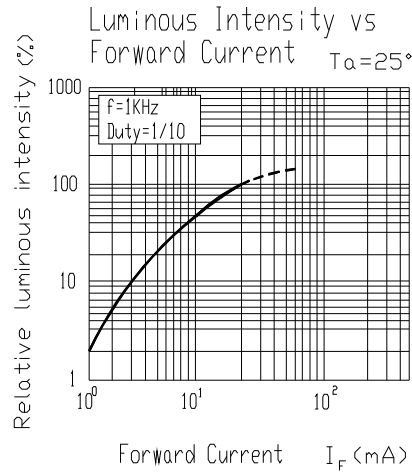
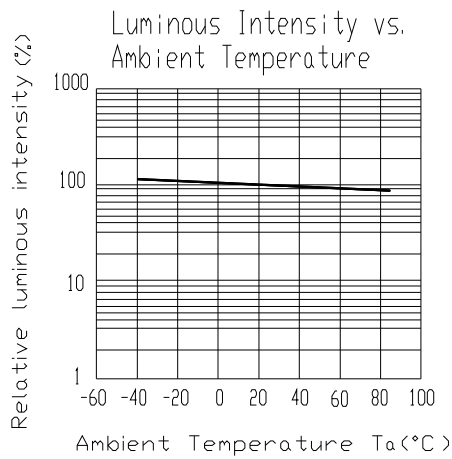
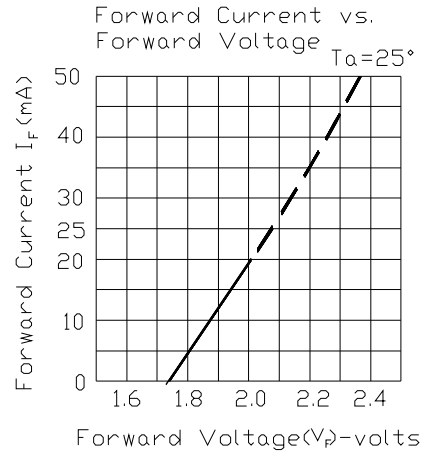
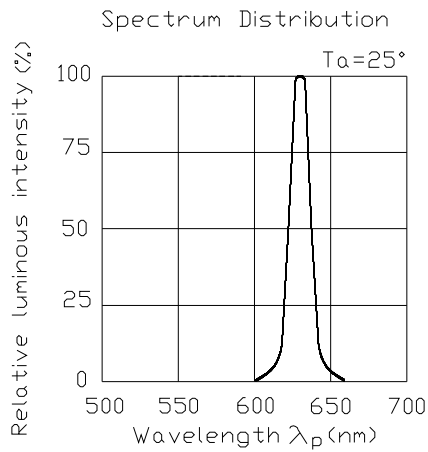
Specific binning requirements- please contact our home office

### Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Luminous Intensity	R6	45	72			If=20mA
	Iv GH	112	180	-----	mcd	
	BH	28.5	45			
Viewing Angle $\theta$	2 1/2	-----	120	-----	deg	If=20mA
Peak Wavelength	R6		632			If=20mA
	$\lambda_p$ GH	-----	518	-----	nm	
	BH		468			
Dominant Wavelength	R6	615		630		If=20mA
	$\lambda_d$ GH	510	-----	540	nm	
	BH	460		480		
Spectrum Radiation Bandwidth	R6		20			If=20mA
	$\Delta \lambda$ GH	-----	35	-----	nm	
	BH		35			
Forward Voltage	R6	1.7	2.0	2.4		If=20mA
	Vf GH	2.7	3.3	3.7	V	
	BH	2.7	3.3	3.7		
Reverse Current	R6			10		Vr=5V
	Ir GH	-----	-----	50	$\mu A$	
	BH			50		

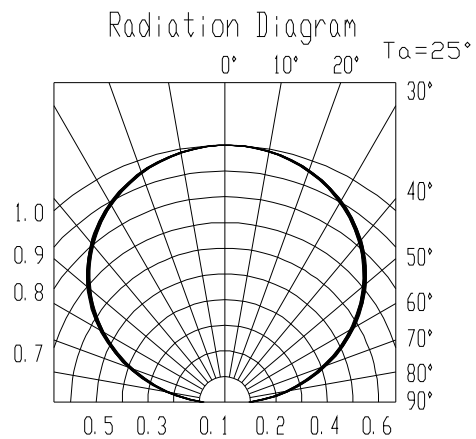
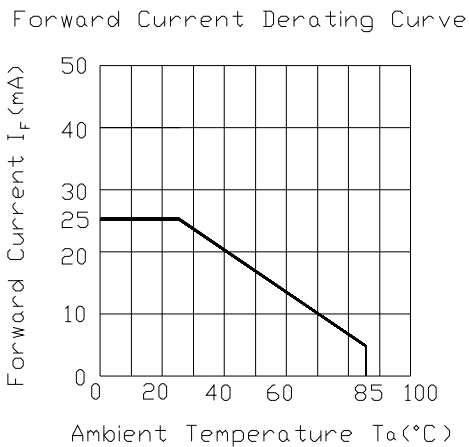
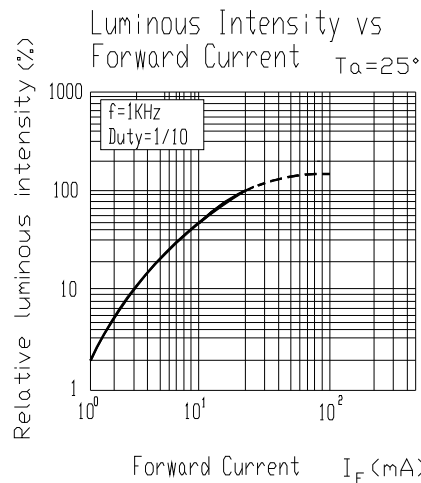
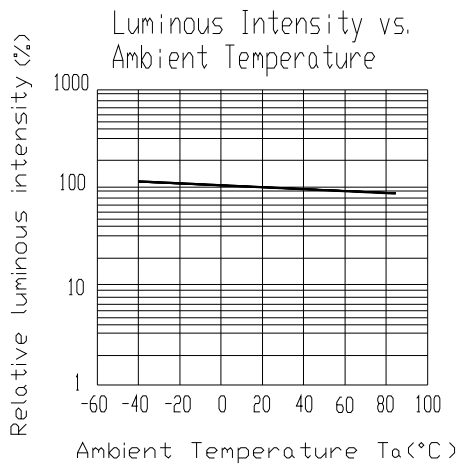
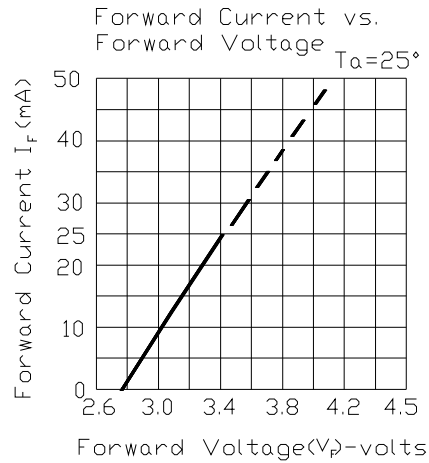
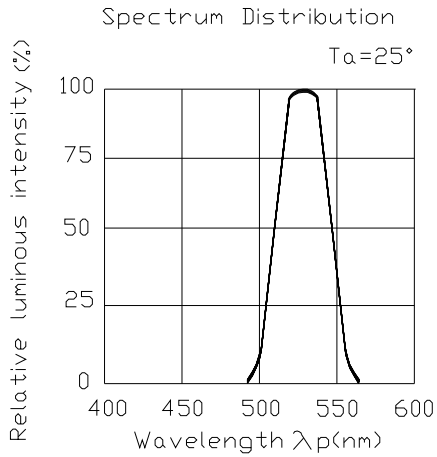
## Typical Electro-Optical Characteristics Curves

### R6



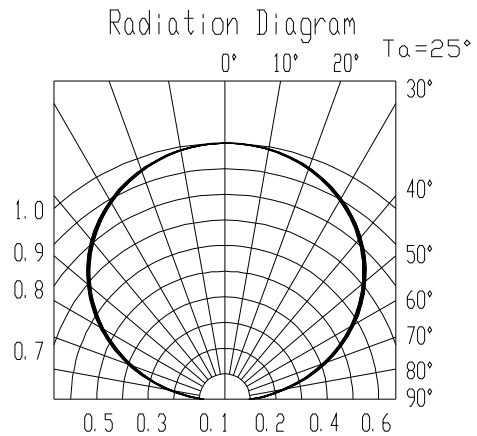
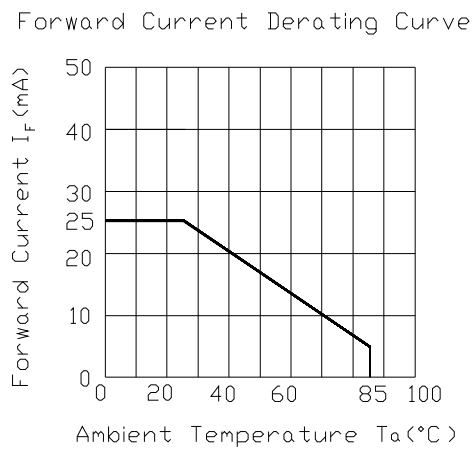
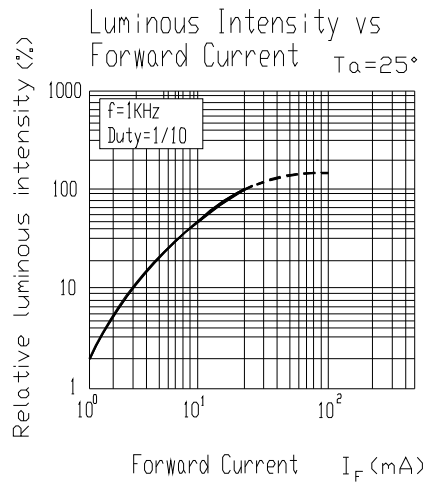
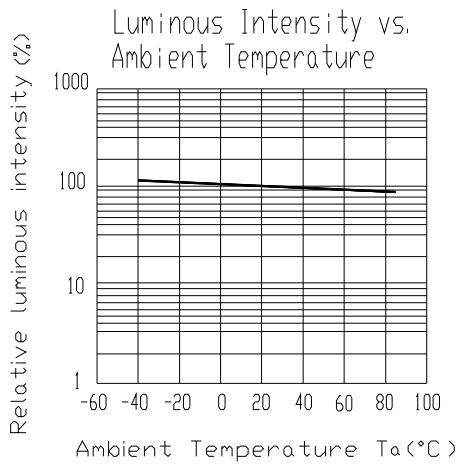
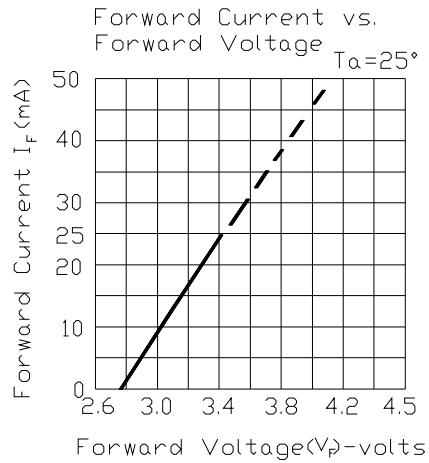
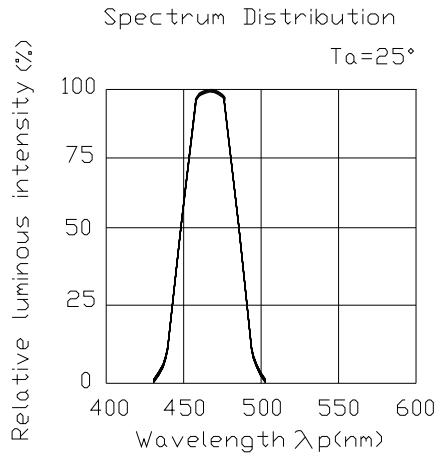
## Typical Electro-Optical Characteristics Curves

GH



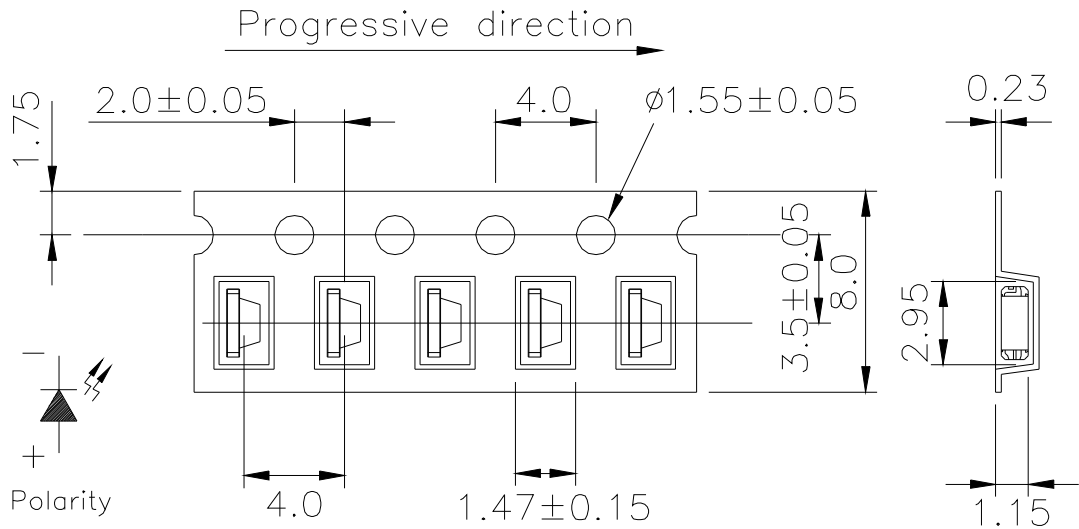
## Typical Electro-Optical Characteristics Curves

BH



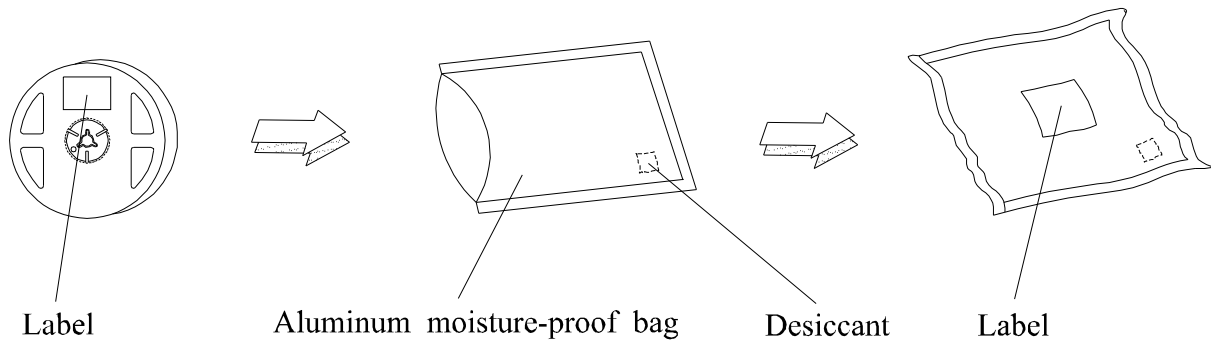


**Carrier Tape Dimensions: Loaded quantity 2000 PCS per reel**



**Note:** The tolerances unless mentioned is  $\pm 0.1\text{mm}$ , Unit = mm

**Moisture Resistant Packaging**





### Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level : 90%

LTPD : 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C ±5°C Min. 5sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	H : +100°C 15min ∫ 5 min L : -40°C 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H : +100°C 5min ∫ 10 sec L : -10°C 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40°C	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	I <sub>F</sub> = 20 mA	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85°C / 85%RH	1000 Hrs.	22 PCS.	0/1

## Precautions For Use

1. Customer must apply resistors for protection, otherwise a slight voltage shift will cause a big current change.

### 2. Storage

2.1 Do not open moisture proof bag before the products are ready to use.

2.2 Before opening the package: The LEDs should be kept at 30°C or less and 90%RH or less.

2.3 After opening the package: The LED's floor life is 1 year under 30 deg C or less and 60% RH or less.

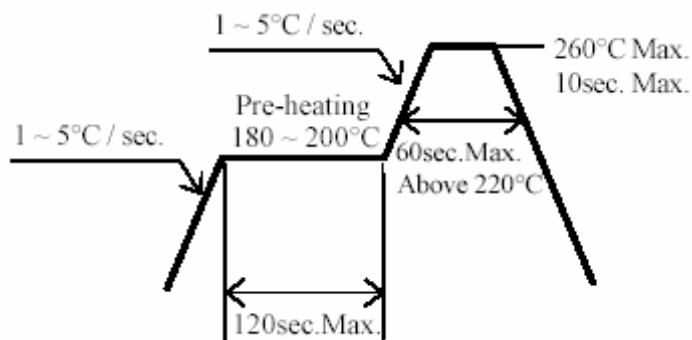
If unused LEDs remain, it should be stored in moisture proof packages.

2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment :  $60\pm 5^{\circ}\text{C}$  for 24 hours.

### 3. Soldering Condition

#### 3.1 Pb-free solder temperature profile



3.2 Reflow soldering should not be done more than two times.

3.3 When soldering, do not put stress on the LEDs during heating.

3.4 After soldering, do not warp the circuit board.

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